Safety Instructions Liquicap M FMI51, FMI52, FTI51, FTI52

II 1/2 G Ex ia IIC Ga / Ex db IIC Gb II 1/2 G Ex ia IIC Ga / Ex db eb IIC Gb II 1/2 D Ex ia IIIC Da / Ex tb IIIC Db







Liquicap M FMI51, FMI52, FTI51, FTI52

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| About this document | This document has been translated into several languages. Legally determined is solely the English source text. |
|-----------------------------|---|
| | The document translated into EU languages is available: In the download area of the Endress+Hauser website: www.endress.com -> Downloads -> Manuals and Datasheets -> Type: Ex Safety Instruction (XA) -> Text Search: In the Device Viewer: www.endress.com -> Product tools -> Access device specific information -> Check device features If not yet available, the document can be ordered. |
| | |
| Associated documentation | This document is an integral part of the following Operating Instructions: |
| | BA00297F/00, BA00298F/00 (FMI51, FMI52) BA00299F/00 (FTI51, FTI52) |
| Supplementary | Explosion-protection brochure: CP00021Z/11 |
| documentation | The Explosion-protection brochure is available: In the download area of the Endress+Hauser website: www.endress.com -> Downloads -> Brochures and Catalogs -> Text Search: CP00021Z On the CD for devices with CD-based documentation |
| Manufacturer's | EU Declaration of Conformity |
| certificates | Declaration Number: EG05020 |
| | The EU Declaration of Conformity is available: In the download area of the Endress+Hauser website: www.endress.com -> Downloads -> Declaration -> Type: EU Declaration -> Product Code: |
| | EU type-examination certificate |
| | Certificate number: BVS 05 ATEX E 090 X |
| | List of applied standards: See EU Declaration of Conformity. |

| Manufacturer address | Endress+Haus Hauptstraße 1 79689 Maulbu Phone: +49 76 Address of the | urg, Gei 522 28- | rmany | namepl | ate. |
|-------------------------|---|---|---|-------------------------------|--------------------------------------|
| Other standards | current versior IEC/EN 600 installations EN 1127-1: | n for pr 79-14: design "Explos | the following stand oper installation: "Explosive atmosph a, selection and erect sive atmospheres - E Basic concepts and | eres - P tion" Explosio | n prevention and |
| Extended order code | The extended order code is indicated on the nameplate, which is affixed to the device in such a way that it is clearly visible. Additional information about the nameplate is provided in the associated Operating Instructions. Structure of the extended order code | | | | |
| | FMI5x, FTI5x | - | **** | + | A*B*C*D*E*F*G* |
| | (Device type) | | (Basic specifications) | | (Optional specifications) |
| | | osition | , an option (number displayed instead of | | er) selected from the iceholders. |
| | Basic specifications | | | | |
| | features) are s | pecifie | absolutely essential d in the basic specifi the number of featu | cations | |

The selected option of a feature can consist of several positions.

Optional specifications

The optional specifications describe additional features for the device (optional features). The number of positions depends on the number of features available. The features have a 2-digit structure to aid identification (e.g. JA). The first digit (ID) stands for the feature group and consists of a number or a letter (e.g. J = Test, Certificate). The second digit constitutes the value that stands for the feature within the group (e.g. A = 3.1 material (wetted parts), inspection certificate).

More detailed information about the device is provided in the following tables. These tables describe the individual positions and IDs in the extended order code which are relevant to hazardous locations.

Extended order code: Liquicap M

The following specifications reproduce an extract from the product structure and are used to assign:

- This documentation to the device (using the extended order code on the nameplate).
- The device options cited in the document.

Device type FMI51, FMI52

Basic specifications

| Position 1 (Approval) | | |
|-----------------------|----|--|
| Selected opti | on | Description |
| FMI5x | L | ATEX II 1/2 G Ex ia IIC T6T3 Ga / Ex db IIC T6T3 Gb, WHG, XA, note safety instruction (XA) (electrostatic charging)! |

| Position 7 (Electronics, Output) | | |
|----------------------------------|---|-------------------------------|
| Selected option | | Description |
| FMI5x | А | FEI50H; 4-20mA HART + display |
| | В | FEI50H; 4-20mA HART |

| Position 8 (Housing) | | |
|----------------------|-------|--|
| Selected o | ption | Description |
| FMI5x | 5 | T13 Alu IP66 NEMA4X + gas-tight probe seal + separate conn. compartment |

| Position 9 (Cable Entry) | | |
|--------------------------|---|--------------------------------|
| Selected option | | Description |
| FMI5x | А | Gland M20 (EEx d > thread M20) |
| | В | Thread G1/2 ¹⁾ |
| | С | Thread NPT1/2 |
| | D | Thread NPT3/4 |

1) Reduction M20x1.5 to G1/2 enclosed

Optional specifications

No options specific to hazardous locations are available.

Device type FTI51, FTI52

Basic specifications

| Position 1 (Approval) | | |
|-----------------------|-----------------|--|
| Selected option | | Description |
| FTI5x | G ¹⁾ | ATEX II 1/2 G Ex ia IIC T6T3 Ga / Ex db eb IIC T6T3 Gb, WHG, XA, ATEX II 1/2 D Ex ia IIIC T_{200} 200°C Da / Ex tb IIIC T90°C Db note safety instruction (XA) (electrostatic charging)! |
| | L | ATEX II 1/2 G Ex ia IIC T6T3 Ga / Ex db IIC T6T3 Gb, WHG, XA, note safety instruction (XA) (electrostatic charging)! |

1) Only in connection with Position 8 = 5

| Position 7 (Electronics, Output) | | | |
|----------------------------------|-----------------|--|--|
| Selected option | | Description | |
| FTI5x | 1 | FEI51; 2-wire 19-253 VAC | |
| | 2 | FEI52; 3-wire PNP 10-55 VDC | |
| | 4 | FEI54; relay DPDT, 19-253 VAC, 19-55 VDC | |
| | 5 ¹⁾ | FEI55; 8/16 mA, 11-35 VDC | |

1) Only in connection with Position 1 = L and Position 8 = 5

| Position 8 (Housing) | | |
|----------------------|---|---|
| Selected option | | Description |
| FTI5x | 4 | F13 Alu IP66 NEMA4X + gas-tight probe seal |
| | 5 | T13 Alu IP66 NEMA4X + gas-tight probe seal + separate conn. compartment |
| | 6 | F27 316L IP66/67 NEMA6P + gas-tight probe seal |

| Position 9 (Cable Entry) | | | |
|--------------------------|---|--------------------------------|--|
| Selected option | | Description | |
| FMI5x | А | Gland M20 (EEx d > thread M20) | |
| | В | Thread G1/2 ¹⁾ | |
| | С | Thread NPT1/2 | |
| | D | Thread NPT3/4 | |

1) Reduction M20x1.5 to G1/2 enclosed

Optional specifications

No options specific to hazardous locations are available.

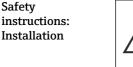
Safety instructions: General

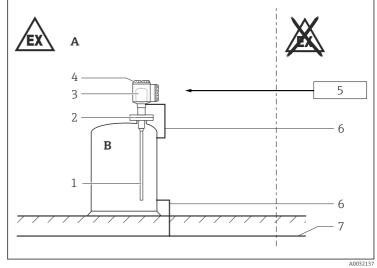
- The device is intended to be used in explosive atmospheres as defined in the scope of EN IEC 60079-0 or equivalent national standards. If no potentially explosive atmospheres are present or if additional protective measures have been taken: The device may be operated according to the manufacturer's specifications.
- Staff must meet the following conditions for mounting, electrical installation, commissioning and maintenance of the device:
 - Be suitably qualified for their role and the tasks they perform
 - Be trained in explosion protection
 - Be familiar with national regulations
- Install the device according to the manufacturer's instructions and national regulations.
- Do not operate the device outside the specified electrical, thermal and mechanical parameters.
- Only use the device in media to which the wetted materials have sufficient durability.
- Avoid electrostatic charging:
 - Of plastic surfaces (e.g. enclosure, sensor element, special varnishing, attached additional plates, ..)
 - Of isolated capacities (e.g. isolated metallic plates)
- Modifications to the device can affect the explosion protection and must be carried out by staff authorized to perform such work by Endress+Hauser.

Safety instructions: Special conditions

- Avoid sparks caused by impact and friction.
- In the case of process connections made of polymeric material or with polymeric coatings, avoid electrostatic charging of the plastic surfaces.
- To avoid electrostatic charging: Do not rub surfaces with a dry cloth.

- In the event of additional or alternative special varnishing on the enclosure or other metal parts or for adhesive plates:
 - Observe the danger of electrostatic charging and discharge.
 - Do not install in the vicinity of processes (≤ 0.5 m) generating strong electrostatic charges.
- The sensors can be installed in the boundary wall between Zone 0 or Zone 20 and the less hazardous area Zone 1 or Zone 21. In this configuration, the process connection is installed in Zone 0 or Zone 20, while the sensor enclosure is installed in Zone 1 or Zone 21.
- Material specification of the separating element: > 10 mm glass feedthrough, edged with > 1 mm stainless steel.





• 1

- A Basic specification, Position 1 = L:Zone 1 Basic specification, Position 1 = G:Zone 1, Zone 21
- B Basic specification, Position 1 = L: Zone 0, [Ex ia]
 - Basic specification, Position 1 = G: Zone 0, Zone 20, [Ex ia]
- 1 Rope or rod probes
- 2 Zone division
- 3 Electronic insert
- 4 Enclosure
- 5 Certified associated apparatus
- 6 Potential equalization line
- 7 Potential equalization

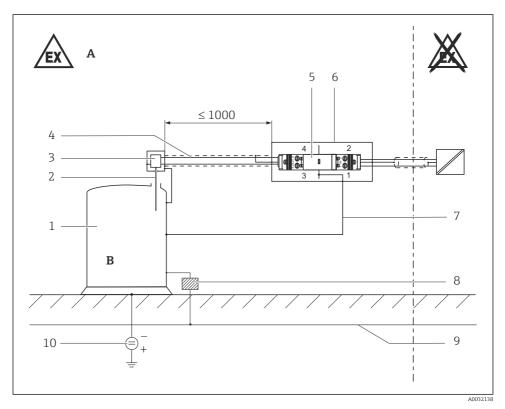
- Install the device to exclude any mechanical damage or friction during the application. Pay particular attention to flow conditions and tank fittings.
- In potentially explosive atmospheres:
 - Do not disconnect the electrical connection of the power supply circuit when energized.
 - Do not open the connection compartment cover and the electronics compartment cover when energized.
- Only use certified cable entries suitable for the application. Observe national regulations and standards. Accordingly, the connection terminal does not include any ignition sources.
- When operating the transmitter enclosure at an ambient temperature under -20 °C, use appropriate cables and cable entries permitted for this application.
- When connecting through a conduit entry approved for this purpose, mount the associated sealing unit directly at the enclosure.
- Seal unused entry glands with approved sealing plugs that correspond to the type of protection. The plastic transport sealing plug does not meet this requirement and must therefore be replaced during installation.
- Before operation:
 - Screw in the cover all the way.
 - Tighten the securing clamp on the cover.
- Observe the maximum process conditions according to the manufacturer's Operating Instructions.
- At high medium temperatures, note flange pressure load capacity as a factor of temperature.
- To maintain the ingress protection of the enclosure IP66/68:
 - Screw the cover tight.
 - Mount the cable entry correctly.
- If a dynamic load is expected: Mechanically fix probes which are more than 3 m.
- Level probes with ground tubes: Suitable for use in Group IIC, IIB, IIA.
- Level probes without ground tubes: Suitable for use in Group IIC, IIB, IIA, if avoiding electrostatic charging of the probe.
 Designation of the device with warning sign: "Avoid electrostatic charging".

Basic specification, Position 1 = G Connect the device:

- Using suitable cable and wire entries of protection type "Increased safety (Ex eb)".
- Using piping systems of protection type "Increased safety (Ex eb)".

Overvoltage protection

For installations which require overvoltage protection to comply with national regulations or standards, install the device using overvoltage protection (e.g. HAW56x from Endress+Hauser).



☑ 2 Dimensions in mm

- A Zone 1
- B Zone O
- 1 Tank
- 2 Probe
- 3 Electronic insert
- 4 e.g. metal hose, metal pipe
- 5 Overvoltage protection, e.g. HAW56xZ
- 6 Grounding via top-hat rail or 51003750 metallic protective enclosure
- 7 Potential equalization line $\geq 4 \text{ mm}^2 \text{ Cu}$
- 8 Insulator (optional)
- 9 Potential equalization
- 10 Cathodic protection (Object voltage ≤ 24 V), (optional)
- Safety instructions: l
- If required or if in doubt: ask manufacturer for specifications.
- Flameproof joints are not intended to be repaired.

instructions: Ex d joints

| Safety instructions: Zone separation Zone 0, Zone 1 | Zone separation realized by the process connections. Versions of process connection: Thread Flange Process connections with thread: Thread pitch ≥ 0.7 Thread engagement ≥ 5 turns Screw-in depth ≥ 8 mm Ensure gas-tight installation of the process connections. After mounting and connecting the probe, it is essential to ensure tightness at the process connection of IP67. It is the responsibility of the plant operator to ensure sealing in the vicinity of the process connection. |
|--|--|
| Safety instructions: Zone 20, Zone 21 | Do not open in a potentially explosive dust atmosphere. Avoid electrostatic charging of the sensor cable (e.g. do not rub dry and install outside the filling flow). |
| Temperature tables | Permitted ambient temperature range at the electronics enclosure: $-50 \degree C \le T_a \le +70 \degree C$ Observe the information in the temperature tables. |

Application in gas

| Device type | FMI51, FMI52, | Basic speci | ification, Positio | n 1 = L |
|-------------|---------------|-------------|--------------------|----------|
| | | | | |

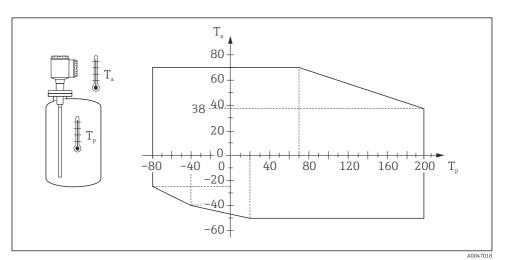
| Basic specification, Position 7 | Temperature class | Ambient temperature T _a (ambient): enclosure | Process temperature T _p (process) |
|------------------------------------|----------------------|---|--|
| А, В | Т6 | $-50 \text{ °C} \le T_a \le +60 \text{ °C}$ | $-80 \ ^\circ\text{C} \le T_p \le +200 \ ^\circ\text{C}$ |
| | T4/T3 | $-50 \text{ °C} \le T_a \le +70 \text{ °C}$ | |

Device type FTI51, FTI52, Basic specification, Position 1 = L, G

| Basic specification, Position 7 | Temperature class | Ambient temperature T _a (ambient): enclosure | Process temperature T_p (process) |
|------------------------------------|----------------------|---|--|
| 1, 2, 4 | Т6 | $-50 \text{ °C} \le T_a \le +60 \text{ °C}$ | $-80 \ ^\circ\text{C} \le T_p \le +200 \ ^\circ\text{C}$ |
| | T4/T3 | $-50 \text{ °C} \le T_a \le +70 \text{ °C}$ | |

| Basic specification, Position 7 | Temperature class | Ambient temperature T _a (ambient): enclosure | Process temperature T _p (process) |
|------------------------------------|----------------------|---|--|
| 5 | T6 | $-50 \text{ °C} \le T_a \le +55 \text{ °C}$ | $-80 ^\circ\text{C} \le T_p \le +200 ^\circ\text{C}$ |
| | T4/T3 | $-50 \text{ °C} \le T_a \le +70 \text{ °C}$ | |

Device type FTI51, FTI52, Basic specification, Position 1 = L



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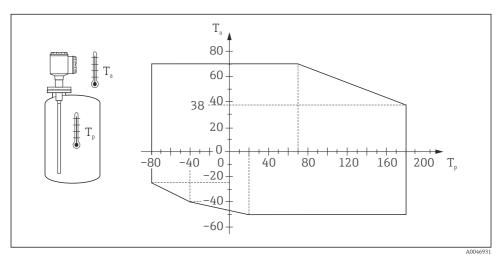
- T_a Ambient temperature in °C
- T_p Process temperature in °C

Application in dust

- Limitations of the maximum ambient temperature at the electronics enclosure may be required dependent on device configuration, process temperatures and temperature classification.
- Maximum heat developed at the probe in Zone 20 under fault conditions and dust layer: < 20 K.
- Maximum heat developed at the enclosure surface in Zone 21 under fault conditions: < 20 K.

| | Probe in Zone 20 | Electronics enclosure in Zone 21 |
|--|---|-------------------------------------|
| Maximum surface temperature at a process temperature or ambient temperature of 70 $^\circ\mathrm{C}$ | $T_{200} 90 \text{ °C at } T_p = +70 \text{ °C }^{1)}$ | T90 °C at T_a = +70 °C |
| Maximum surface temperature for probe process temperatures ≥80 to 180 °C, under compliance of the permitted ambient temperature at the electronics enclosure. | $T_{200} 200 \ ^{\circ}C \ at \ T_{p} = +180 \ ^{\circ}C$ | T90 °C at T _a = +38 °C |

1) Surface temperature at a process temperatures above 70 °C: T_p = +20 K



€ 4

- T_a Ambient temperature in °C
- T_p Process temperature in °C

Connection data

Device type FMI51, FMI52, Basic specification, Position 1 = L

| Basic specification, Position 7 | Electrical data |
|---------------------------------|---|
| A, B | $\begin{array}{l} U \leq 30 \; V_{DC} \\ P \leq 1 \; W \end{array}$ |

| Basic specification, Position 7 | Power supply | Relay circuit |
|---------------------------------|---------------------------|---|
| 1 | 19 to 253 V _{AC} | - |
| 2 | 10 to 55 V_{DC} | - |
| 4 | 19 to 253 V _{AC} | $\begin{array}{l} 253 \ V_{AC} \ / \ 4 \ A \\ 1 \ 500 \ VA \ / \ \cos \phi = 1 \\ 750 \ VA \ / \ \cos \phi > 0.7 \end{array}$ |
| | 19 to 55 V _{DC} | 30 V _{DC} / 4 A 125 V _{DC} / 0.2 A |

Device type FTI51, FTI52, Basic specification, Position 1 = L, G

| Device type F1 | TI51. FTI52. | Basic specifica | tion, Position $1 = L$ |
|----------------|--------------|-----------------|------------------------|
| | | | |

| Basic specification, Position 7 | Electrical data |
|---------------------------------|---|
| 5 | $\begin{array}{l} U \leq 35 \ V_{DC} \\ P \leq 1 \ W \end{array}$ |



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